SPECIFICATIONS

CUSTOMER .

SAMPLE CODE . SH480272T006-IAA02

MASS PRODUCTION CODE . PH480272T006-IAA02

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 005

DRAWING NO. (Ver.) . LMD-PH480272T006-IAA02(Ver.003)

PACKAGING NO. (Ver.) . PKG- PH480272T006-IAA02(Ver.002)

Customer Approved

Date:

Approved	Checked	Designer
廖志豪	張慶源	陳宗淇
Rex Liao	Yuan Chang	Howard Chen

Preliminary specification for design input Specification for sample approval 2015.10.20 TW RD APR

POWERTIP TECH. CORP.

Headquarters: No.8, 6th Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8號

TEL: 886-4-2355-8168

FAX: 886-4-2355-8166

E-mail: sales@powertip.com.tw

Http://www.powertip.com.tw



History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
05/22/2014	01	001	New Drawing.	-	Howard
06/04/2014	01	002	Second Drawing Disp pin internal connect to H Modify Frame Drawing	12 Appendix	Howard
07/15/2014	01	003	New Sample	-	Howard
05/26/2015	01	004	Modify Average Brightness Add LED Life Time Add Rear View	6 9 Appendix	Howard
10/20/2015	01	005	Modify Packaging Specification	Appendix	Howard
		X			

Total: 27 Pages



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix: 1. LCM Drawing

2. Packaging Specification

Note: For detailed information please refer to IC data sheet:

Primacy(TFT LCD): Sitronix--ST7282-G4

(Or compatible IC)



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	480 * 3 (RGB) * 272 Dots
LCD Type	a-Si TFT , Normally white, Transmissive type
Screen size(inch)	4.3 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Backlight Type	LED B/L
Interface	Digital 24-bits RGB
Other(controller/driver IC)	ST7282-G4 (Or Compatible IC)
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	105.5(W) x 67.2 (L) x 2.6(H) +0,-0.2	mm

LCD panel

Item	Standard Value	Unit
Viewing Area	96.7 (W) * 55.3 (L)	mm
Active Area	95.04 (W) x 53.856 (L)	mm
Pixel Size	0.198 (W) * 0.198 (H)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	GND=0	-0.3	4.6	٧
Operating Temperature	T _{OP}	-	-20	70	°C
Storage Temperature	T _{ST}	1	-30	80	°C
Storage Humidity	H_D	Ta < 60 °C	10	90	%RH

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
	VDD	-	3.0	3.3	3.6	V
Power Supply Voltage	VGH		13	15	16	V
	VGL		-10	-10	-7	V
Input H/L Level Voltage	VIH	-	0.7VDD	ı	VDD	V
input 17/L Level voltage	VIL	-	0	ı	0.3VDD	V
Output H/L Level	VOH	-	VDD-0.4	ı	VDD	V
Voltage	VOL	-	0	ı	GND+0.4	V
Supply Current	I _{DD}	VDD = 3.3 V Pattern=Photo *1	-	25	40	mA

Note1:Maximum current display



1.5 Optical Characteristics

TFT LCD Module

VDD= 3.3 V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time	Tr+Tf	25	-	-	30	- (ms	-
	Тор	θΥ+		-	60			
Viewine en ale	Bottom	θΥ-	00 > 40	-	60	-	Day	Niete 4
Viewing angle	Left	θХ-	CR ≥ 10	-	60	-	Deg.	Note 4
	Right	θX+		-	60	-		
Contrast rati	0	CR		500	600	-	-	Note 3
	White	Х		0.24	0.29	0.34		
	vviile	Υ		0.29	0.34	0.39		
Color of CIE	Red	X	Ta = 25°C	0.54	0.59	0.64		
Color of CIE Coordinate	Reu	Υ	θX , $\theta Y = 0^{\circ}$	0.29	0.34	0.39		Note1
(With B/L)	Green	X	0, 01 = 0	0.28	0.33	0.38	-	Note
(With D/L)	Green	Υ		0.57	0.62	0.67		
	Blue	X		0.10	0.15	0.20		
	Diue	Υ	.4	0.06	0.11	0.16		
Average Brightr	ness							
Pattern=white display		IV	IF= 20 mA	310	460	-	cd/m2	Note1
(With LCD)*1								
Uniformity (With LCD)*	2	В	IF= 20 mA	70	-	-	%	Note1



Note 1:

*1: B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

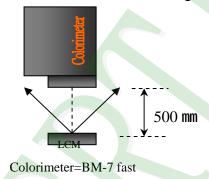
a: Environment: 25 ±5 / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





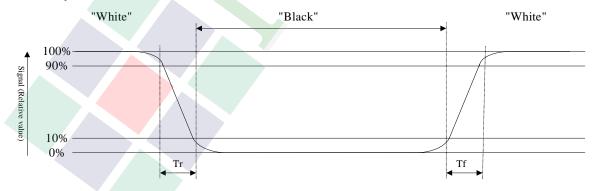
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

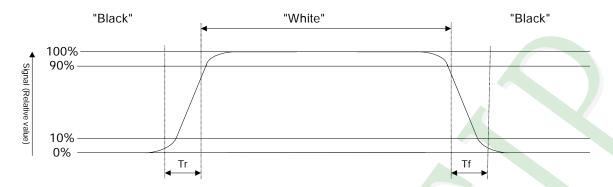
Refer to figure as below:

Normally White





Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

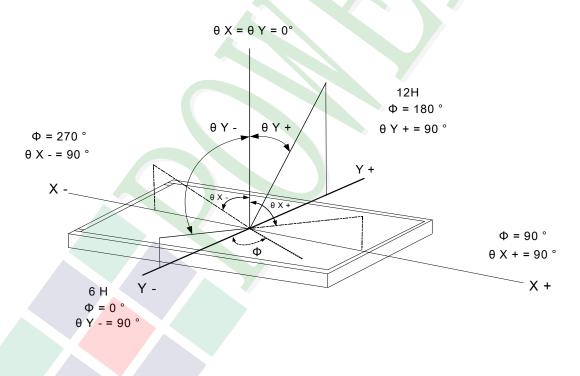
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

- Maximum Ratings					
Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25	_	30*1	mA
(Each LED)	11	14 –25	_	30 1	IIIA
LED Reverse Voltage	VR	Ta =25		5.0	V
(Each LED)	VIX	1a -25	-	5.0	V
Power Dissipation	PD	Ta =25		90*8	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		-	25.6) /-	V
Average Brightness (Without LCD)	IV	IF=20mA	6500	7800	1	cd/m ²
CIE Color Coordinate	X		-	0.28	ı	
(Without LCD)	Y		-	0.30	ı	1
Color			White			
LED Lifetime	20000 Hrs at 25					

B/L Internal Circuit Diagram:





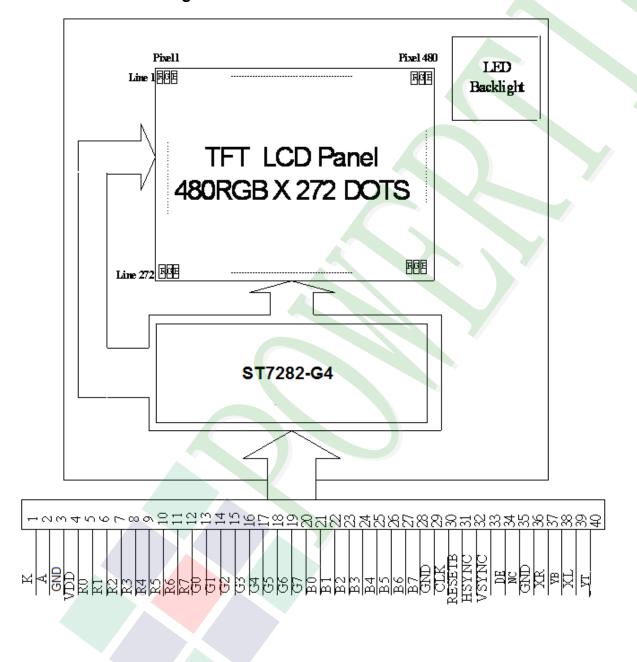
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function
1	K	Power supply for LED Backlight cathode input
2	Α	Power supply for LED Backlight anode input
3	GND	Ground
4	VDD	Digital power
5	R0	Red data bit 0
6	R1	Red data bit 1
7	R2	Red data bit 2
8	R3	Red data bit 3
9	R4	Red data bit 4
10	R5	Red data bit 5
11	R6	Red data bit 6
12	R7	Red data bit 7
13	G0	Green data bit 0
14	G1	Green data bit 1
15	G2	Green data bit 2
16	G3	Green data bit 3
17	G4	Green data bit 4
18	G5	Green data bit 5
19	G6	Green data bit 6
20	G7	Green data bit 7

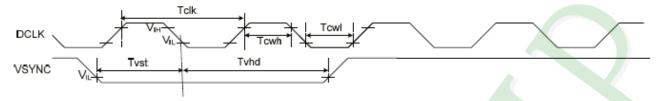


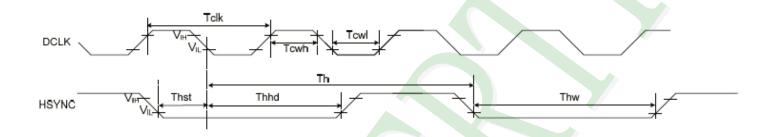
Pin No.	Symbol	Function
21	В0	Blue data bit 0
22	B1	Blue data bit 1
23	B2	Blue data bit 2
24	В3	Blue data bit 3
25	B4	Blue data bit 4
26	B5	Blue data bit 5
27	В6	Blue data bit 6
28	B7	Blue data bit 7
29	GND	Ground
30	CLK	Dot data clock
31	DISP	Display control / standby mode selection "High": Normal display
32	HSYNC	Horizontal sync input
33	VSYNC	Vertical sync input
34	DE	Data input enable. Active High to enable the data input
35	N.C	Not Connect.
36	GND	Ground
37	XR	Not Connect.
38	YB	Not Connect.
39	XL	Not Connect.
40	YT	Not Connect.



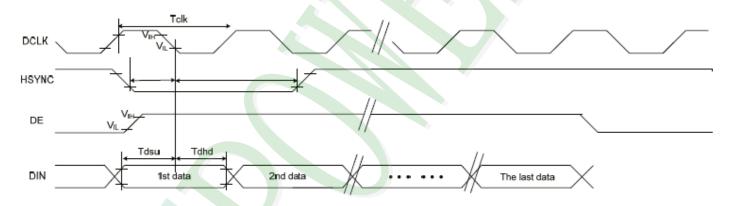
2.3 Timing Characteristics

2.3.1Clock and Data Input Timing





2.3.2 SYNC-DE MODE





Item	Symbol	Min.	Тур.	Max.	Unit	Conditions
System operation timing						
VDD power source slew time	TPOR	-	-	20	ms	From 0V to 99% VDD
GRB pulse width	tRSTW	10	50	-	us	R=10Kohm, C=1uF
Input/ Output timing						
CLK pulse duty	Tcw	40	50	60	%	
Hsync width	Thw	1	-	-	DCLK	
Hsync period	Th	55	60	65	us	
Vsync setup time	Tvst	12	-	-	ns	
Vsync hold time	Tvhd	12	-	-	ns	
Hsync setup time	Thst	12	-	-	ns	
Hsync hold time	Thhd	12	<u></u>	-	ns	
Data setup time	Tdsu	12	-	V-	ns	* /
Data hold time	Tdhd	12	-	-	ns	
SD output stable time	Tst	-	-	12	ùs	Output settled within +20mV
						Loading = 6.8k+28.2pF.
GD output rise and fall time	Tgst	-	-	6	us	Output settled (5%~95%),
						Loading = 4.7k+29.8pF



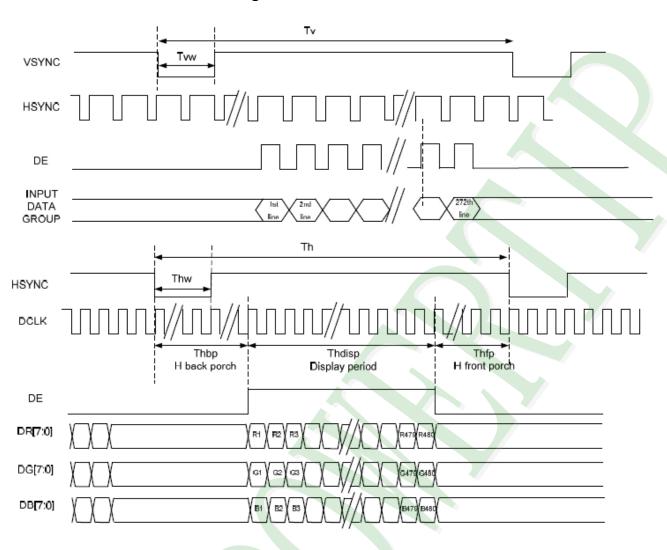


2.3.3Parallel RGB Input Timing Table

	Item	Symbol	Min.	Тур.	Max.	Unit	Remark
DCLK Frequency		Fclk	9	12	15	MHz	
DCLK Peri	od	Tclk	67	83	111	ns	
HSYNC	Period Time	Th	485	525	532	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	50	DCLK	By H_Blanking setting
	Front Porch	Thfp	2	2	2	DCLK	
	Pulse Width	Thw	1	1	1	DCLK	
VSYNC	Period Time	Tv	275	285	303	H	
	Display Period	Tvdisp		272		Н	
	Back Porch	Tvbp	2	12	30	Н	By V_Blanking setting
	Front Porch	Tvfp	1	1	1	H	
	Pulse Width	Tvw	1	1	1	Н	



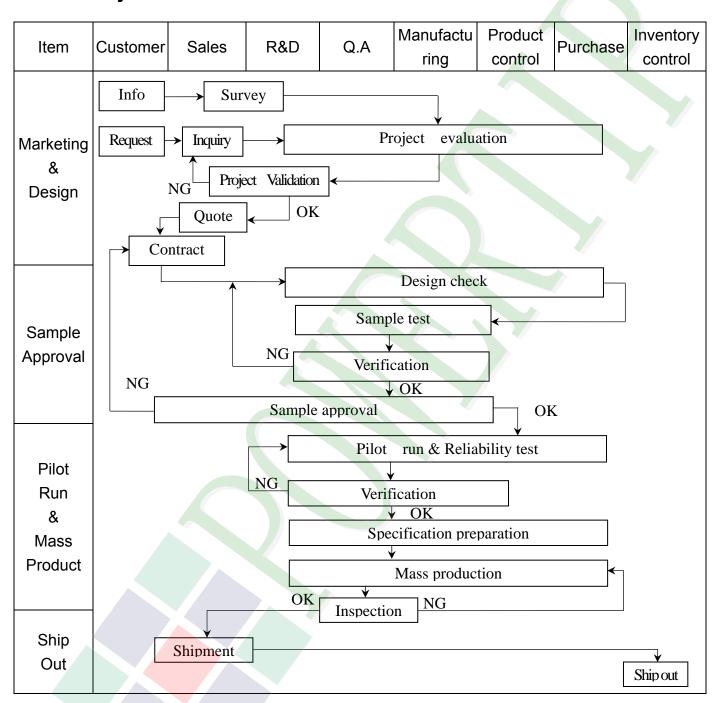
2.3.4 SYNC-DE Mode Timing



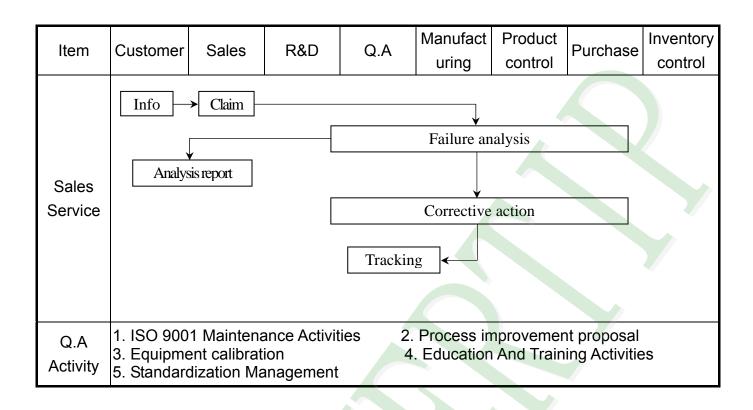


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3, 5" ~10" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample

◆Defect Level: Major Defect AQL: 0.4 ; Minor Defect AQL: 1.5

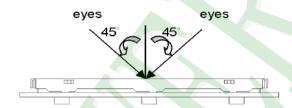
♦OUT Going Defect Level: Sampling.

◆Standard of the product appearance test:

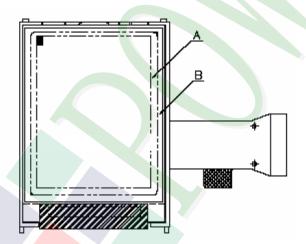
a. Manner of appearance test:

(1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



NO	Item	Criterion	Level			
	Product condition	1. 1The part number is inconsistent with work order of production.				
01		1. 2 Mixed product types.	Major			
		1. 3 Assembled in inverse direction.	Major			
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major			
		4. 1 Missing line character and icon.	Major			
	Electrical Testing	4. 2 No function or no display.				
04		4. 3 Display malfunction.				
		4. 4 LCD viewing angle defect.				
		4. 5 Current consumption exceeds product specifications.	Major			
		Item Acceptance (Q'ty)				
	Dot defect	Bright Dot ≤ 4				
	Dot delect	Dot Dark Dot ≤ 5				
	(Bright dot \	Defect Joint Dot ≤ 3				
05	Dark dot) On -display	Total ≤ 7	Minor			
		 5. 1 Inspection pattern: full white, full black, Red, Green and blue screens. 5. 2 It is defined as dot defect if defect area > 1/2 dot. 5. 3 The distance between two dot defect ≥5 mm. 				



NO	Item	Criterion Criterion	Level
		6. 1 Round type (Non-display or display) :	
		Dimension (diameter : Φ)	
	Black or white dot > scratch >	$\Phi \le 0.25$ Ignore	
	contamination	$0.25 < \Phi \le 0.50$	
	Round type	$\Phi > 0.50$ Ignore	
	$\begin{array}{c c} \rightarrow & \leftarrow \\ \hline & & \\ \hline & & \\ \end{array}$	Total 5	
06	$\Phi = (x+y)/2$	6. 2 Line type(Non-display or display) :	Minor
	(x 1 3) / 2	Length (L) Width (W) Acceptance (Q'ty)	
	Line type	Length (L) Width (W) A area B area	
	~ ↑ w	$W \le 0.03$ Ignore $L \le 10.0$ $0.03 < W \le 0.05$ 4	
		$L \le 5.0$ $0.05 < W \le 0.10$ 2 $Ignore$	
		W >0.10 As round type	
		Total 5	
		Dimension (diameter : Φ) Acceptance (Q'ty) A area B area	
		$\Phi \le 0.25$ Ignore	
07	Polarizer	$0.25 < \Phi \leq 0.50 \qquad \qquad 4$	Minor
	Bubble	$0.50 < \Phi \le 0.80$ 1 Ignore	
		$\Phi > 0.80 \qquad \qquad 0$	
		Total 5	



NO	Item	Criterion		Level				
		Z: The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length					
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and cra	ack between panels:					
		Y Z Z	Z Y Y					
08	The crack of glass	SP Y [OK]	[NG]	Minor				
		Seal width Z						
		X Y	z					
		≤ a Crack can't enter viewing area	≤1/2 t					
		≤ a Crack can't exceed the half of SP width.	1/2 t < Z ≤2 t					



◆Specification For TFT-LCD Module 3. 5″ ~10″: (Ver.B01)

NO	Item		Cr	iterion		Level			
		X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:							
		X	Y		Z				
		≤1/5 a	Crack can't e viewing ar		$Z \leq 1/2 t$				
		≤1/5 a	Crack can't exc half of SP wi		$t < Z \leq 2 t$				
08	The crack of glass	8.2 Protru	sion over termi	nal:		Mino			
		8. 2. 1 Chi	p on electrode	pad:					
		WY	X	Z	X Y Z				
		W X							
			X	Y	Z				
		Front Back		≤ 1/2 W ≤ W	$\leq t$ $\leq 1/2 t$				
		Dack	<u> </u>	= ₩	⇒ 1/2 t				



◆Specification For TFT-LCD Module 3. 5″ ~10″: (Ver.B01)

Itom	Cuitovian	Lovel				
Item						
The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 2. 2 Non-conductive portion: X X X Y Z S If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8. 2. 3 Glass remain:	Level				
		Z: The thickness of crack t: The thickness of glass 8. 2. 2 Non-conductive portion: X				



NO	Item	Criterion	Level
		9. 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
	General appearance	10. 1 Pin type \quantity \dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION					
1	High Temperature Storage Test	Keep in +80 ±2 96 hrs Surrounding temperature, then storage at normal condition 4hrs.					
2	Low Temperature Storage Test	Keep in -30 ±2 96 hrs Surrounding temperature, then storage at normal condition 4hrs.					
3	High Temperature / High Humidity Storage Test	Keep in +60 / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)					
4	Temperature Cycling Storage Test	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$					
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance : 15					
6	Vibration Test (Packaged)	 Sine wave 10 55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm Each direction (X, Y, Z) duration for 2 Hrs 					
7	Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm) 0 ~ 45.4 122 45.4 ~ 90.8 76 90.8 ~ 454 61 Over 454 46 Drop Direction: 1 corner / 3 edges / 6 sides each 1 time					



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10 and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25 ±5 and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

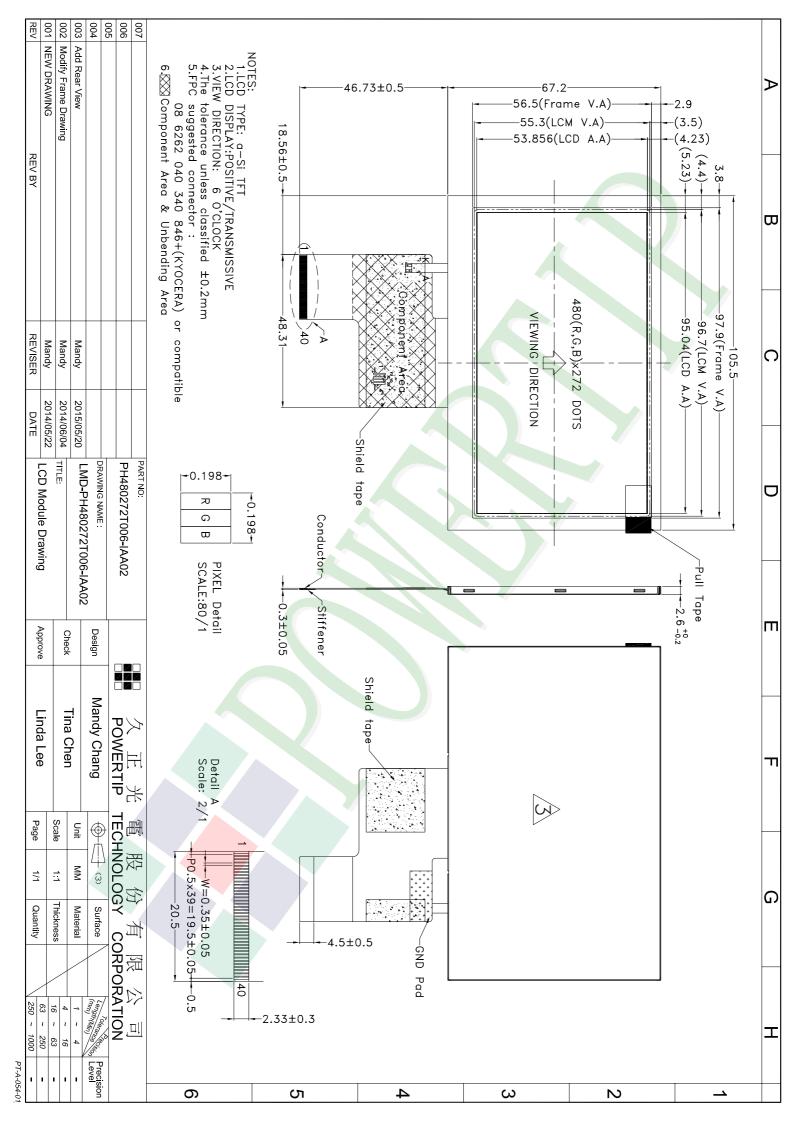
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver.002

Documents NO. PKG-PH480272T006-IAA02

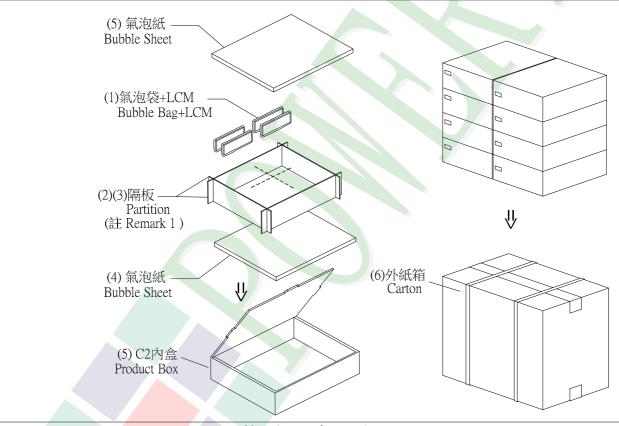
LCM包裝規格書 LCM Packaging Specifications

Approve	Check	Contact	
Linda Lee	Tina Chen	Mandy Chang	

1.包裝材料規格表 (Packaging Material): (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH480272T006-IAA02	105.5 X 67.2 X 2.6	0.0412	192	7.9104
2	氣泡袋(1)Bubble Bag	BAG000000005	150 X 120	0.002	192	0.384
3	A2-1隔板(2)A2-1 Partition	BX29500072BZBA	295 X 72 X 3.0	0.0109	56	0.6104
4	B2-1隔板(3)B2-1 Partition	BX24500072BZBA	245 X 72 X 3.0	0.0094	24	0.2256
5	氣泡紙(4)Bubble Sheet	BAG280240BWABA	280 X 240	0.006	16	0.096
6	C2內盒(5)Product Box	BX31025580AABA	310 X 255 X 86	0.16	8	1.28
7	外紙箱(6)Carton	BX52732536CCBA	527 X 325 X 360	0.83	1	0.83
8						þ.
9						

- 2.一 整箱總重量 (Total LCD Weight in carton): 11.34 Kg±10%
- 3.單箱數量規格表 (Packaging Specifications and Quantity):
 - (1)Quantity Of Spacer: A2-1隔板 X 7/2, B2-1隔板 X 3
- (2) Total LCM quantity in carton: quantity per box 24 x no of boxes 8 = 192



特記事項(REMARK)

- 4. LCM排放示意圖(前後間隔不放置):
- 4. LCM placed as figure showing: (First and last slot should be empty)

